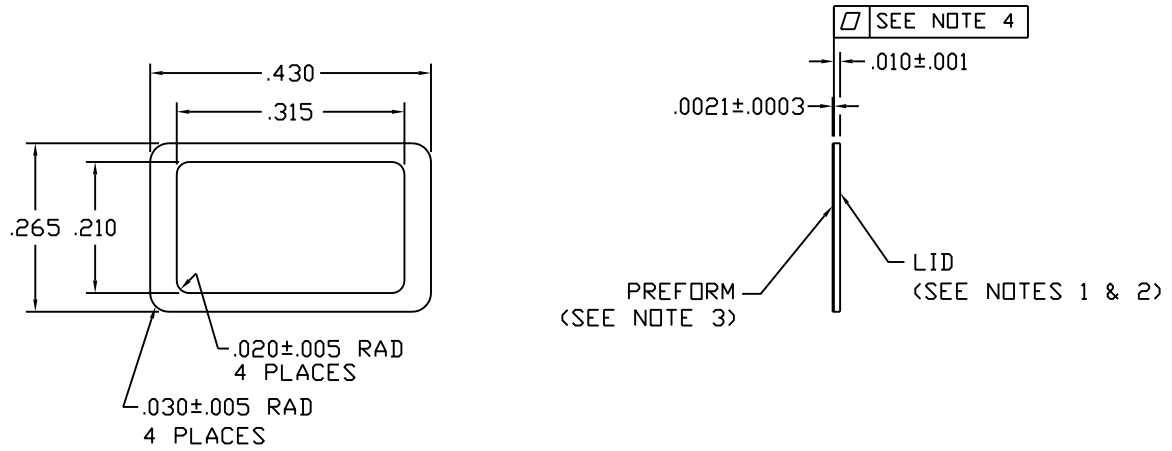


# SSM P/N CL432608



**NOTES**

1. MAT'L : KOVAR OR ALLOY 42
2. PLATING : 1st LAYER 50/350 MICROINCHES Ni  
 2nd LAYER Au  
 3rd LAYER 50/350 MICROINCHES Ni  
 4th LAYER 25 MICROINCHES MINIMUM Au
- NOTES : TOTAL NICKEL LAYERS SHALL NOT EXCEED 450 MICROINCHES AND THE SUM OF BOTH GOLD LAYERS SHALL BE 50 MICROINCHES MINIMUM.
3. PREFORM - 80% ±1% Au  
 20% Sn
4. FLATNESS : ONE MIL (.001) MAXIMUM PER 1/2" T.I.R
5. TOLERANCES TO BE (XXX) 3 PLACES ±.003 UNLESS OTHERWISE NOTED

|  |    |             |   |
|--|----|-------------|---|
| DESIGN   | BW | 08/03<br>89 | DESCRIPTION<br>Hi-Rel Combo Lid                             |
| APPRO  | VG | 03/08<br>00 | PART NAME<br>CL432608                                       |
| Spectrum Semiconductor Materials, Inc.<br>2027 O'Toole Ave<br>San Jose, CA 95131<br>PH: (408) 435-5555 Fx: (408)435-8226 |    |             | SCALE 4 = 1<br>DEPT   |
|  |    |             | MFG: WILLIAMS ADVANCED MATERIALS, INC.<br>PART No.<br>W415H |

